# 74ALVC541-Q100

# Octal buffer/line driver; 3-state

Rev. 3 — 30 April 2021

**Product data sheet** 

### 1. General description

The 74ALVC541-Q100 is an octal non-inverting buffer/line drivers with 3-state bus compatible outputs. The 3-state outputs are controlled by the output enable inputs  $\overline{\text{OE}}0$  and  $\overline{\text{OE}}1$ . A HIGH on  $\overline{\text{OE}}$ n causes the outputs to assume a high-impedance OFF-state.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 3) and is suitable for use in automotive applications.

#### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 3)
  - Specified from -40 °C to +85 °C
- Wide supply voltage range from 1.65 V to 3.6 V
- Complies with JEDEC standard:
  - JESD8-7 (1.65 V to 1.95 V)
  - JESD8-5 (2.3 V to 2.5 V)
  - JESD8B (2.7 V to 3.6 V)
- 3.6 V tolerant inputs/outputs
- CMOS LOW power consumption
- Direct interface with TTL levels (2.7 V to 3.6 V)
- Power-down mode
- Latch-up performance exceeds 250 mA
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0  $\Omega$ )
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

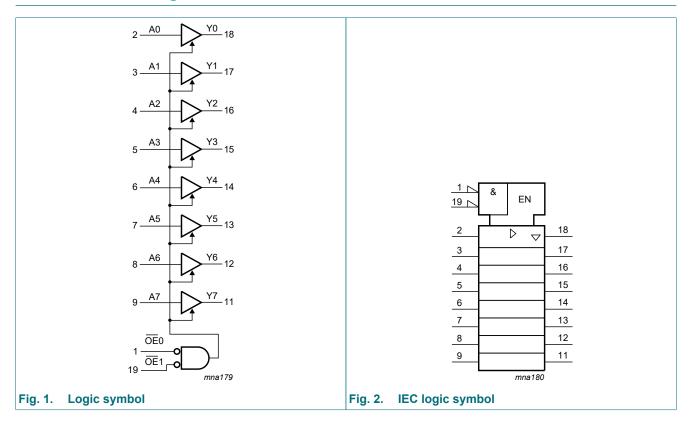
# 3. Ordering information

**Table 1. Ordering information** 

Type number	Package								
	Temperature range	Name	Description	Version					
74ALVC541D-Q100	-40 °C to +85 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1					
74ALVC541PW-Q100	-40 °C to +85 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1					
74ALVC541BQ-Q100 -40 °C to +85 °C		DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm	SOT764-1					

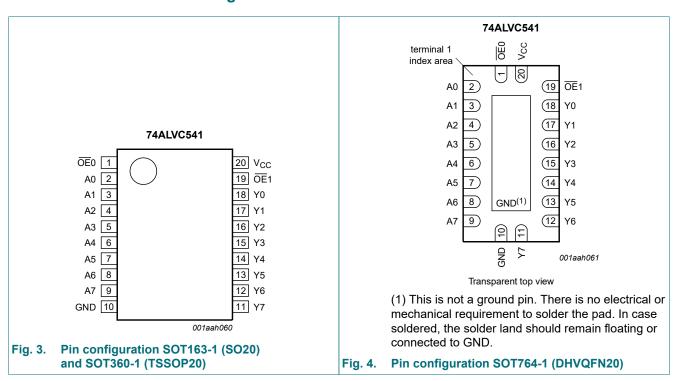


# 4. Functional diagram



# 5. Pinning information

### 5.1. Pinning



### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
ŌE0	1	output enable input (active LOW)
A0, A1, A2, A3, A4, A5, A6, A7	2, 3, 4, 5, 6, 7, 8, 9	data input
GND	10	ground (0 V)
Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7	18, 17, 16, 15, 14, 13, 12, 11	data output
ŌE1	19	output enable input (active LOW)
V <sub>CC</sub>	20	supply voltage

# 6. Functional description

#### Table 3. Functional table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Control		Input	Output Yn	
OE0	OE1	An		
L	L	L	L	
L	L	Н	Н	
X	Н	X	Z	
Н	X	X	Z	

# 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+4.6	V
VI	input voltage		[1]	-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-50	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> > V <sub>CC</sub> or V <sub>O</sub> < 0 V		-	±50	mA
Vo	output voltage	output HIGH or LOW state	[2]	-0.5	V <sub>CC</sub> + 0.5	V
		output 3-state	[2]	-0.5	+4.6	V
		power-down mode; V <sub>CC</sub> = 0 V		-0.5	+4.6	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$		-	±50	mA
I <sub>CC</sub>	supply current			-	100	mA
I <sub>GND</sub>	ground current			-100	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb}$ = -40 °C to +85 °C		-	500	mW

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

3 / 13

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	output HIGH or LOW state	0	V <sub>CC</sub>	V
		output 3-state	0	3.6	V
		power-down mode; V <sub>CC</sub> = 0 V	0	3.6	V
T <sub>amb</sub>	ambient temperature		-40	+85	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 1.65 V to 2.7 V	-	20	ns/V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	10	ns/V

### 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> =	-40 °C to	+85 °C	Unit
			Min	Typ[1]	Max	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7V	1.7	-	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.35 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7V	-	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	V <sub>CC</sub> - 0.2	-	-	V
		I <sub>O</sub> = 6mA ; V <sub>CC</sub> = 1.65 V	1.25	-	-	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.3 V	1.8	-	-	V
		I <sub>O</sub> = 18 mA; V <sub>CC</sub> = 2.3 V	1.7	-	-	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	2.2	-	-	V
		I <sub>O</sub> = 18 mA; V <sub>CC</sub> = 3.0 V	2.4	-	-	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	2.2	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	-	0.2	V
		I <sub>O</sub> = -6mA ; V <sub>CC</sub> = 1.65 V	-	-	0.3	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.3 V	-	-	0.4	V
		I <sub>O</sub> = -18 mA; V <sub>CC</sub> = 2.3 V	-	-	0.6	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V	-	-	0.4	V
		I <sub>O</sub> = -18 mA; V <sub>CC</sub> = 3.0 V	-	-	0.4	V
		I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V	-	-	0.55	V
I <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; $V_{CC} = 3.6 \text{ V}$	-	±0.1	±10.0	μΑ
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 3.6 \text{ V}$	-	±0.1	±5.0	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O} = 0 \text{ V to } 3.6 \text{ V; } V_{CC} = 0 \text{ V}$	-	±0.1	±10.0	μA

Symbol	Parameter	Conditions	T <sub>amb</sub> =	Unit		
		Min	Typ[1]	Max		
Icc	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6$ V	-	0.2	10	μΑ
ΔI <sub>CC</sub>	additional supply current	per input pin; V <sub>CC</sub> = 3.0 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A	-	5	750	μΑ
Cı	input capacitance		-	3.5	-	pF

[1] All typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.8 V, 2.5 V, 2.7 V and 3.3 V.

## 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7.

Symbol	Parameter	Conditions	T <sub>aml</sub>	o = -40 °C to	+85 °C	Unit
			Min	Typ[1]	Max	
t <sub>pd</sub>	propagation	An to Yn; see Fig. 5 [2]				
	delay	V <sub>CC</sub> = 1.65V to 1.95 V	1.0	3.0	4.6	ns
		V <sub>CC</sub> = 2.3V to 2.7 V	1.0	2.2	3.3	ns
		V <sub>CC</sub> = 2.7 V	1.0	2.5	3.3	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.3	3.0	ns
t <sub>en</sub>	enable time	OEn to Yn; see Fig. 6 [2]				
		V <sub>CC</sub> = 1.65V to 1.95 V	1.0	4.2	7.5	ns
		V <sub>CC</sub> = 2.3V to 2.7 V	1.0	3.3	5.4	ns
		V <sub>CC</sub> = 2.7 V	1.0	3.7	5.8	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	3.3	4.9	ns
t <sub>dis</sub>	disable time	OEn to Yn; see Fig. 6 [2]				
		V <sub>CC</sub> = 1.65V to 1.95 V	1.0	4.8	7.5	ns
		V <sub>CC</sub> = 2.3V to 2.7 V	1.0	3.1	4.5	ns
		V <sub>CC</sub> = 2.7 V	1.0	3.1	4.8	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.9	4.6	ns
C <sub>PD</sub>	power dissipation	per buffer; $V_I$ = GND to $V_{CC}$ ; $V_{CC}$ = 3.3 $V$ [3]				
	capacitance	outputs enabled	-	25	-	pF
		outputs disabled	-	0	-	pF

- All typical values are measured at Tamb = 25  $^{\circ}$ C and V<sub>CC</sub> = 1.8 V, 2.5 V, 2.7 V and 3.3 V.
- t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

 $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

 $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ . [3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

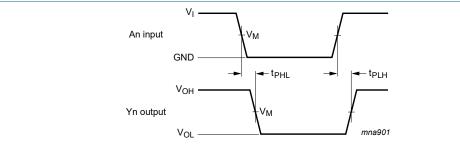
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of the outputs.

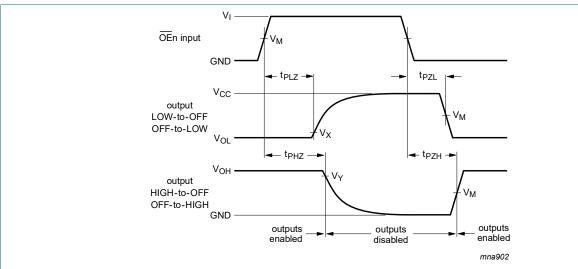
#### 10.1. Waveforms and test circuit



Measurement points are given in Table 8.

V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

Fig. 5. Propagation delay input (An) to output (Yn)



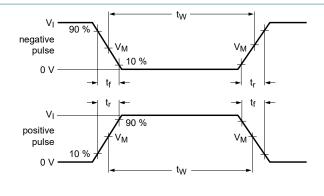
Measurement points are given in Table 8.

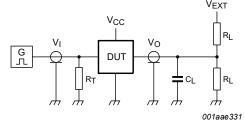
 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output levels that occur with the output load.

Fig. 6. Enable and disable times

**Table 8. Measurement points** 

Supply voltage	Input		Output				
V <sub>CC</sub>	v <sub>CC</sub> V <sub>I</sub>		V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>		
1.65 V to 1.65V	V <sub>CC</sub>	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V		
2.3 V to 2.7 V	V <sub>CC</sub>	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V		
2.7 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V		
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V		





Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator

 $C_L$  = Load capacitance including jig and probe capacitance

R<sub>L</sub> = Load resistor

Fig. 7. Test circuit for measuring switching times

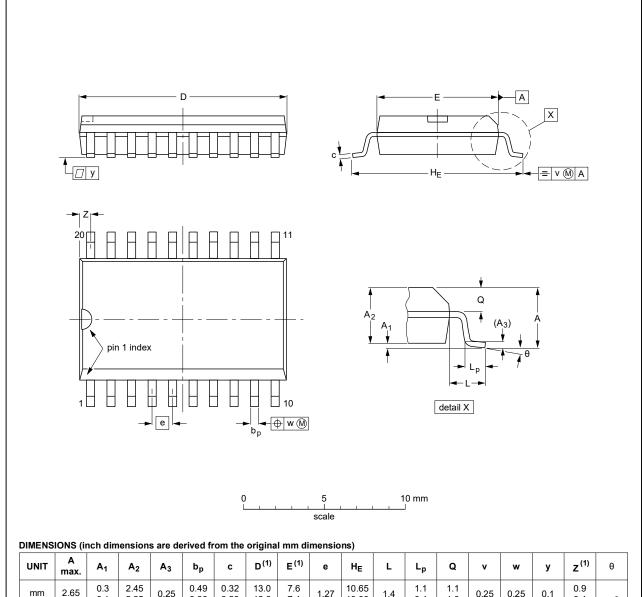
Table 9. Test data

Supply voltage			Load		V <sub>EXT</sub>			
V <sub>CC</sub>			f C <sub>L</sub> R <sub>L</sub>		t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	zL t <sub>PHZ</sub> , t <sub>PZH</sub>	
1.65 V to 1.95 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	1 kΩ	open	2 × V <sub>CC</sub>	GND	
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	500 Ω	open	2 × V <sub>CC</sub>	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	6 V	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	6 V	GND	

# 11. Package outline

#### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	z <sup>(1)</sup>	θ
mm	2.65	0.3 0.1	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.1	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.05	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

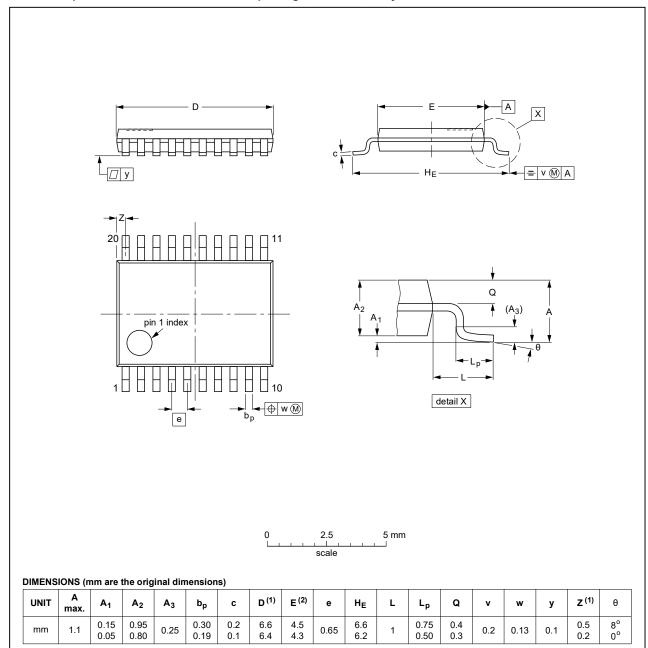
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

	OUTLINE		REFER	EUROPEAN	ISSUE DATE		
	VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	SOT163-1	075E04	MS-013				<del>99-12-27</del> 03-02-19

Fig. 8. Package outline SOT163-1 (SO20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN	ISSUE DATE	
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT360-1		MO-153				<del>99-12-27</del> 03-02-19

Fig. 9. Package outline SOT360-1 (TSSOP20)

Notes

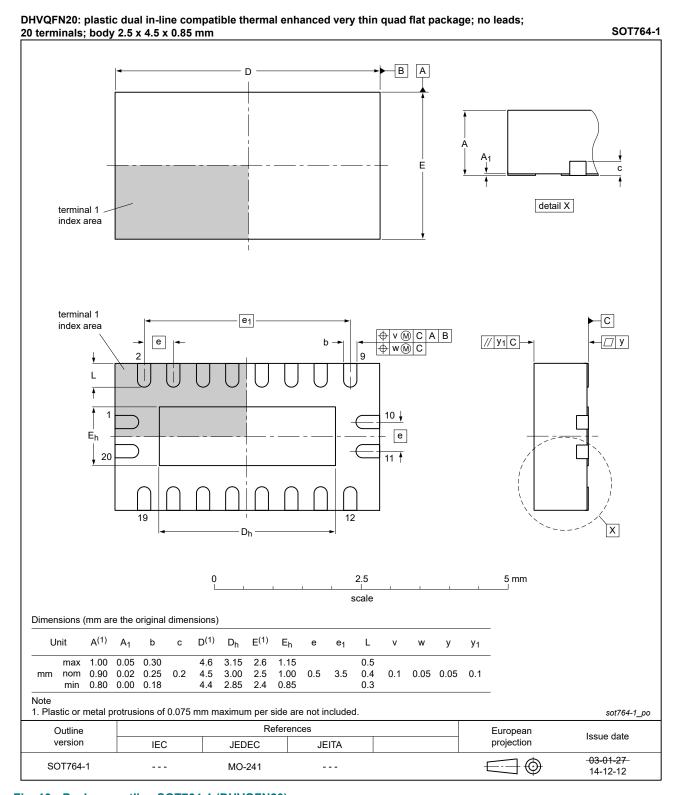


Fig. 10. Package outline SOT764-1 (DHVQFN20)

### 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MIL	Military
MM	Machine Model
TTL	Transistor-Transistor Logic

# 13. Revision history

#### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74ALVC541_Q100 v.3	20210430	Product data sheet	-	74ALVC541_Q100 v.2	
Modifications:	<ul> <li><u>Section 2</u>: Reference to JESD36 removed.</li> <li><u>Table 4</u>: Derating values for P<sub>tot</sub> total power dissipation removed (errata).</li> </ul>				
74ALVC541_Q100 v.2	20200930	Product data sheet	-	74ALVC541_Q100 v.1	
Modifications:	Nexperia.  Legal texts have be Section 2 updated.	or company name where			
74ALVC541_Q100 v.1	20140519	Product data sheet	-	-	

### 14. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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### **Contents**

1. General de	scription	1
2. Features a	nd benefits	1
3. Ordering in	formation	1
4. Functional	diagram	2
5. Pinning inf	ormation	2
5.1. Pinning		2
5.2. Pin descri	ption	3
6. Functional	description	3
7. Limiting va	lues	3
8. Recommen	ded operating conditions	4
9. Static char	acteristics	4
10. Dynamic o	characteristics	5
10.1. Waveform	ns and test circuit	6
11. Package o	outline	8
12. Abbreviat	ions	11
13. Revision I	nistory	11
14. Legal info	rmation	12

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13 / 13

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